

June 2015

1N/FDLL 914/A/B / 916/A/B / 4148 / 4448 Small Signal Diode



DO-35
Cathode is denoted with a black band

THE PLACEMENT OF THE EXPANSION GAP HAS NO RELATIONSHIP TO THE LOCATION OF THE CATHODE TERMINAL

SOD80

SOD-80 COLOR BAND MARKING

DEVICE 1ST BAND

FDLL914 BLACK
FDLL914B BLACK
FDLL4148 BLACK
FDLL4148 BLACK
FDLL4448 BLACK

-1st band denotes cathode terminal and has wider width

Ordering Information

| Part Number | Marking | Package | Packing Method | |
|---------------|---------|------------------|-----------------------|--|
| 1N914 | 914 | DO-204AH (DO-35) | Bulk | |
| 1N914_T50A | 914 | DO-204AH (DO-35) | Ammo | |
| 1N914TR | 914 | DO-204AH (DO-35) | Tape and Reel | |
| 1N914ATR | 914A | DO-204AH (DO-35) | Tape and Reel | |
| 1N914B | 914B | DO-204AH (DO-35) | Bulk | |
| 1N914BTR | 914B | DO-204AH (DO-35) | Tape and Reel | |
| 1N916 | 916 | DO-204AH (DO-35) | Bulk | |
| 1N916A | 916A | DO-204AH (DO-35) | Bulk | |
| 1N916B | 916B | DO-204AH (DO-35) | Bulk | |
| 1N4148 | 4148 | DO-204AH (DO-35) | Bulk | |
| 1N4148TA | 4148 | DO-204AH (DO-35) | Ammo | |
| 1N4148_T26A | 4148 | DO-204AH (DO-35) | Ammo | |
| 1N4148_T50A | 4148 | DO-204AH (DO-35) | Ammo | |
| 1N4148TR | 4148 | DO-204AH (DO-35) | Tape and Reel | |
| 1N4148_T50R | 4148 | DO-204AH (DO-35) | Tape and Reel | |
| 1N4448 | 4448 | DO-204AH (DO-35) | Bulk | |
| 1N4448TR | 4448 | DO-204AH (DO-35) | Tape and Reel | |
| FDLL914 | Black | SOD-80 | Tape and Reel | |
| FDLL914A | Black | SOD-80 | Tape and Reel | |
| FDLL914B | Black | SOD-80 | Tape and Reel | |
| FDLL4148 | Black | SOD-80 | Tape and Reel | |
| FDLL4148_D87Z | Black | SOD-80 | Tape and Reel | |
| FDLL4448 | Black | SOD-80 | Tape and Reel | |
| FDLL4448_D87Z | Black | SOD-80 | Tape and Reel | |

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

| Symbol | Parameter | Value | Unit | |
|------------------|---|----------------------|-------------|----|
| V _{RRM} | Maximum Repetitive Reverse Voltage | | 100 | V |
| Io | Average Rectified Forward Current | 200 | mA | |
| I _F | DC Forward Current | 300 | mA | |
| I _f | Recurrent Peak Forward Current | | 400 | mA |
| I _{FSM} | Non-repetitive Peak Forward Surge Current | Pulse Width = 1.0 s | 1.0 | А |
| | Non-repetitive Feak Folward Surge Current | Pulse Width = 1.0 μs | 4.0 | Α |
| T _{STG} | Storage Temperature Range | | -65 to +200 | °C |
| TJ | Operating Junction Temperature Range | | -55 to +175 | °C |

Note:

1. These ratings are limiting values above which the serviceability of the diode may be impaired.

Thermal Characteristics

| Symbol | Parameter | Max. | |
|-----------------|---|---|------|
| | | 1N/FDLL 914/A/B / 916/A/B / 4148 / 4448 | Unit |
| P _D | Power Dissipation | 500 | mW |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 300 | °C/W |

Electrical Characteristics(2)

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

| Symbol | Para | ameter | Conditions | Min. | Max. | Unit |
|-----------------|-----------------------|--------------------|---|------|-------|------|
| V_{R} | Breakdown Voltage | | I _R = 100 μA | 100 | | V |
| | | | I _R = 5.0 μA | 75 | | V |
| V _F | Forward Voltage | 914B / 4448 | I _F = 5.0 mA | 0.62 | 0.72 | V |
| | | 916B | I _F = 5.0 mA | 0.63 | 0.73 | V |
| | | 914 / 916 / 4148 | I _F = 10 mA | | 1.0 | V |
| | | 914A / 916A | I _F = 20 mA | | 1.0 | V |
| | | 916B | I _F = 20 mA | , | 1.0 | V |
| | | 914B / 4448 | I _F = 100 mA | | 1.0 | V |
| | Reverse Leakage | | V _R = 20 V | | 0.025 | μΑ |
| I _R | | | V _R = 20 V, T _A = 150°C | | 50 | μΑ |
| | | | V _R = 75 V | | 5.0 | μΑ |
| C _T | Total Capacitance | 916/916A/916B/4448 | V _R = 0, f = 1.0 MHz | | 2.0 | pF |
| | | 914/914A/914B/4148 | V _R = 0, f = 1.0 MHz | | 4.0 | pF |
| t _{rr} | Reverse Recovery Time | | $I_F = 10 \text{ mA}, V_R = 6.0 \text{ V } (600 \text{ mA})$ $I_{rr} = 1.0 \text{ mA}, R_L = 100 \Omega$ | | 4.0 | ns |

Note:

2. Non-recurrent square wave P_W = 8.3 ms.

Typical Performance Characteristics

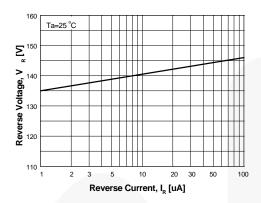


Figure 1. Reverse Voltage vs. Reverse Current B_V - 1.0 to 100 μA

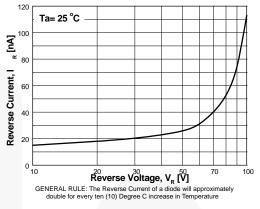


Figure 2. Reverse Current vs. Reverse Voltage I_R - 10 to 100 V

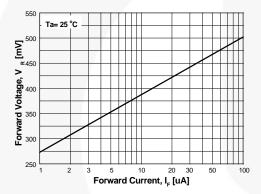


Figure 3. Forward Voltage vs. Forward Current V_F - 1 to 100 μA

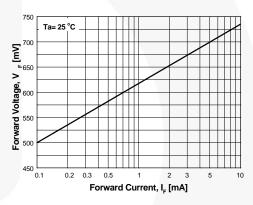


Figure 4. Forward Voltage vs. Forward Current V_F - 0.1 to 10 mA

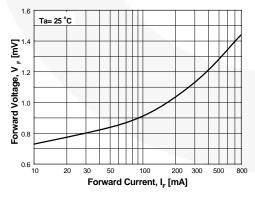


Figure 5. Forward Voltage vs. Forward Current V_F - 10 to 800 mA

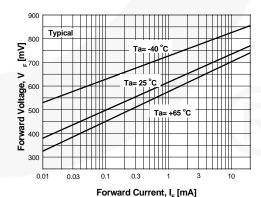


Figure 6. Forward Voltage vs. Ambient Temperature V_F - 0.01 - 20 mA (- 40 to +65°C)

Typical Performance Characteristics (Continued)

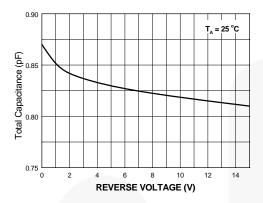


Figure 7. Total Capacitance

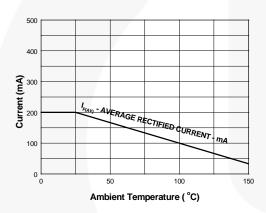


Figure 9. Average Rectified Current ($I_{F(AV)}$) vs. Ambient Temperature (T_A)

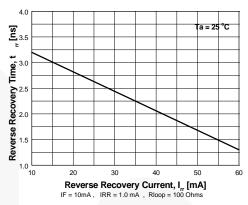


Figure 8. Reverse Recovery Time vs. Reverse Recovery Current

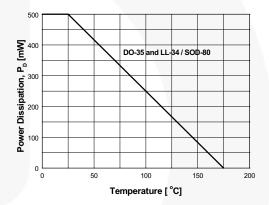
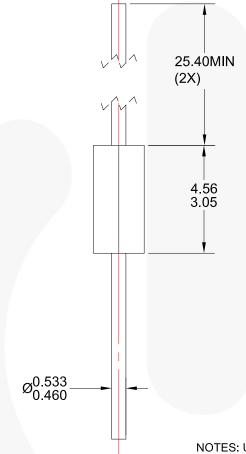


Figure 10. Power Derating Curve

Physical Dimensions



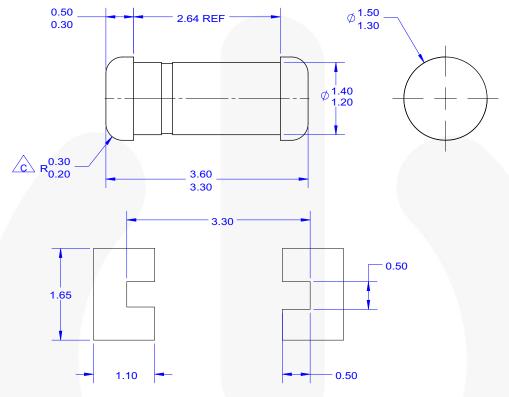
NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE:
 JEDEC DO-204, VARIATION AH.
 B) HERMETICALLY SEALED GLASS PACKAGE.
 C) PACKAGE WEIGHT IS 0.137 GRAM.
 D) ALL DIMENSIONS ARE IN MILLIMETERS.
 E) DRAWING FILE NAME:DO35AREV02

Figure 11. AXIAL LEADED, GLASS, JEDEC DO204, VARIATION AH, DO-204AH (DO-35)

 $\emptyset_{1.53}^{1.91}$

Physical Dimensions (Continued)



LAND PATTERN RECOMMENDATION

NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE: JEDEC DO-213, VARIATION AC.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- CORNER RADIUS IS OPTIONAL.
- D) LAND PATTERN RECOMMENDATION PER IPC DIOMELF3414N
- E) DRAWING FILE NAME: SOD80A REV3



Figure 12. 2-TERMINAL, SOD-80, JEDEC DO-213AC, MINI-MELF





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

BitSiC™ Green FPS™ Build it Now™ Green FPS™ e-Series™

Current Transfer Logic™ Making Small Speakers Sound Louder DEUXPEED® and Better™

Dual Cool™

EcoSPARK®

EfficientMax™

ESBC™

MicroPak™

MicroPak™

MicroPak™

MicroPak™

MillerDrive™ Fairchild® MotionMax™ Fairchild Semiconductor® MotionGrid® FACT Quiet Series™ MTi[®] FACT® FAST® MTx® MVN® FastvCore™ mWSaver® FETBench™ OptoHiT™ **FPSTM** OPTOLOGIC® OPTOPLANAR®

Power Supply WebDesigner™

PowerTrench[®]
PowerXS™

Programmable Active Droop™

QFĔT[®]
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™

SYSTEM GENERAL®*

TinyBoost®
TinyBuck®
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWire™
TranSiC™
TriFault Detect™

TriFault Detect™
TRUECURRENT®*
μSerDes™

SerDes"
UHC[®]
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™
Msens™
仙童™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT http://www.fairchildsemi.com, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN, NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Definition of Terms | | | |
|--------------------------|-----------------------|---|--|
| Datasheet Identification | Product Status | Definition | |
| Advance Information | Formative / In Design | Datasheet contains the design specifications for product development. Specifications may change in any manner without notice. | |
| Preliminary | First Production | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. | |
| No Identification Needed | Full Production | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design. | |
| Obsolete | Not In Production | Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only. | |

Rev. 174

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: 1N4448 1N4448TR